



Metalon® Conductive Inks for Printed Electronics

www.novacentrix.com

Metalon® HPSC-U363

High Conductivity Silver-Coated Copper Screen Ink

GENERAL INFORMATION

- Particle:** 3-micron silver-coated copper particles (63% w/w Cu)
- Substrates:** Paper, plastics, glass, metals
- Features:**
- Economical pricing
 - High metal loading (87% w/w metal)
 - High conductivity for low temperature curing
 - Excellent water and alcohol resistance
 - Flexible and good adhesion
 - Printing equipment cleans with isopropanol
 - Conductivity can be adjusted with Ag amount
 - Solderable

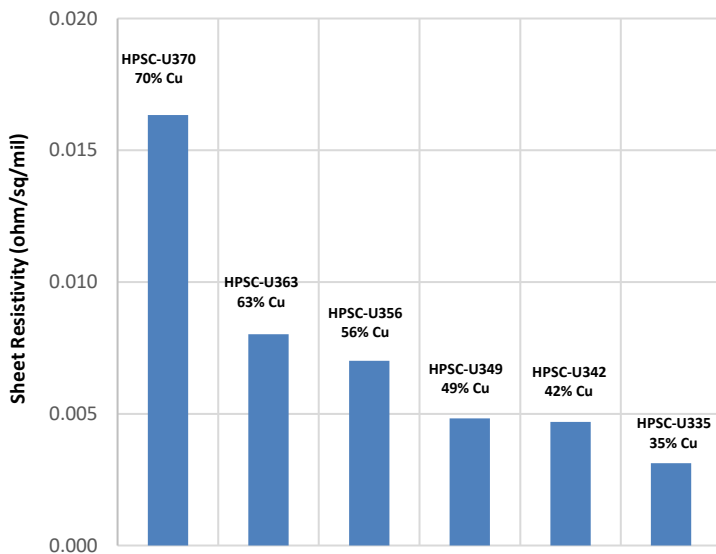
THERMAL CURE DATA

Cure Temperature ¹ (°C)	Cure Time (minutes)	Volume Resistivity ² (Ω-cm)	Sheet Resistivity ² (Ω/sq/mil)
80	120	5.2E-05	0.021
100	60	3.5E-05	0.014
120	15	2.5E-05	0.010
140	15	2.2E-05	0.009
150	15	2.2E-05	0.009
175	15	2.2E-05	0.009
200	10	2.2E-05	0.009

¹Pre-cure drying at 140C for 10 minutes for cure ≥ 175C

²Typical value (#10 drawdown and 25% porosity - typical dried coating 0.013g/cm²)

HPSC-U Silver-coated copper inks (cured at 140C)



Physical Properties	General description.....	Ag-coated Cu particle ink
	Viscosity (typical values)...	143,000 cP at 10 sec ⁻¹ 72,000 cP at 100 sec ⁻¹
	Specific gravity.....	4.5
	Particle size.....	D50 - 3 microns
	Metal content.....	87% w/w
Storage and Printing	Storage.....	Room temperature
	Shelf life.....	> 6 months
	Cleaning solvent.....	Isopropanol
	Screen mesh material.....	Stainless steel or polyester
	Screen mesh count.....	325 to 80 wires per inch
Shipping and Packaging	MOQ - 100 grams	

www.novacentrix.com
Contact us today to learn more.
nova.sales@novacentrix.com